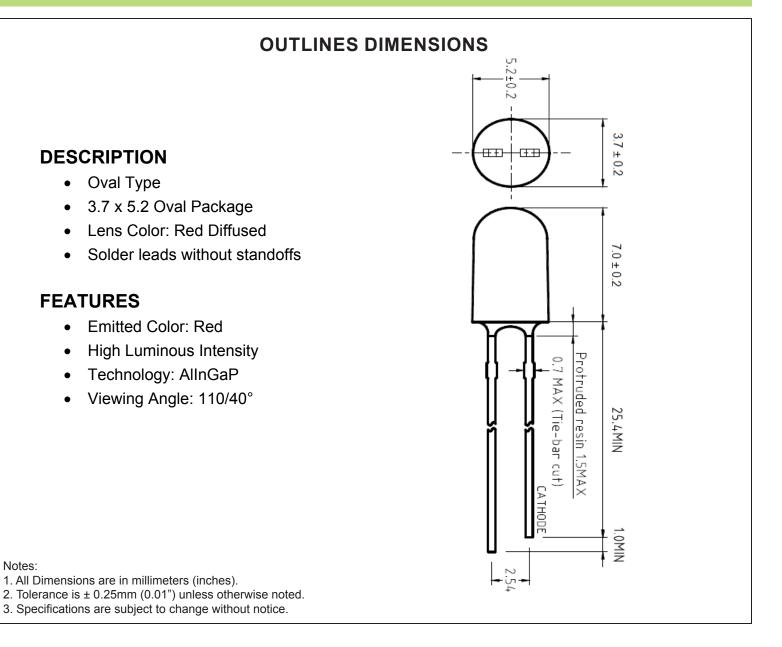


SPECIFICATIONS

CLV54SR2D-110



| Part Number | Chip Material | Color of Emission | Lens Type | Viewing Angle |
|---------------|---------------|-------------------|--------------|---------------|
| CLV54SR2D-110 | InGaAIP | Red | Red Diffused | 110/40° |



ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com



ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Max Rating | Unit |
|-------------------------------|------------------|------------|------|
| Power Dissipation | PD | 120 | mW |
| Pulse Current Forward Current | I _{FP} | 100 | mA |
| Continuous Forward Current | IF | 50 | mA |
| Reverse Voltage | V _R | 5.0 | V |
| Operating Temperature Range | T _{OPR} | -30 ~ +85 | °C |
| Storage Temperature Range | T _{STG} | -40 ~ +100 | °C |

 I_{FP} = Pulse Width \leq 10 ms, Duty Ratio \leq 1/10.

Soldering Condition: 260 °C/ 5sec

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

| Parameter | Symbol | Test Condition | Min | Тур | Max | Unit |
|--------------------------|--------|-----------------------|-----|---------|------|------|
| Luminous Intensity | lv | I _F = 20mA | 680 | 900 | 1900 | mcd |
| Forward Voltage | VF | I _F = 20mA | | 2.1 | 2.4 | V |
| Reverse Leakage Current | IR | $V_R = 5V$ | | | 50 | μA |
| Viewing Angle | 201/2 | I _F = 20mA | | 110/40° | | deg. |
| Peak Wavelength | λP | I _F = 20mA | | 635 | | nm |
| Dominant Wavelength | λ | I _F = 20mA | 615 | 625 | 635 | nm |
| Spectral Line half-width | Δλ | I _F = 20mA | | 15 | | nm |

*Tolerance of viewing angle: -10 / +5 deg.



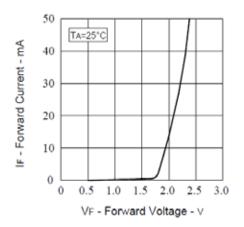
ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com

(TA=25°C

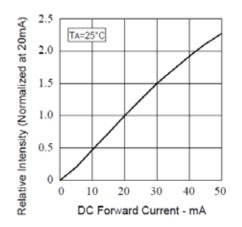


OPTICAL CHARACTERISTIC CURVES

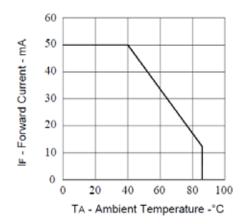
Forward Current vs.Forward Voltage



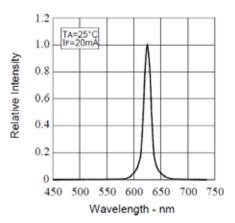
Relative Intensity vs.Forward Current



Forward Current vs.Ambient Temperature



Relative Intensity vs.Wavelength





ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com



SOLDERING CONDITIONS – LAMP TYPE LED

- * Solder the LED no closer than 3mm from the base of the epoxy bulb. Soldering beyond the base of the tie bar is recommended.
- * Recommended soldering conditions

| Dip Soldering | | | |
|-------------------------|--|--|--|
| Pre-Heat | 100 °C Max | | |
| Pre-Heat Time | 60 Second Max | | |
| Solder Bath Temperature | 260 °C Max | | |
| Dippng Time | 5 Second Max | | |
| Dipping Position | No lower than 3mm from the base of the epoxy | | |

| Hand Soldering | | | | |
|--|-----------------------------|-----------------------------|--|--|
| Temperature Soldering Time Position | 3mm Series | Others | | |
| | 300 °C Max | 350 °C Max | | |
| | 3 Second Max | 3 Second Max | | |
| | No closer than 3mm from the | No closer than 3mm from the | | |
| | base of the epoxy | base of the epoxy | | |

- * Do not apply any stress to the lead. Particularly when heated.
- * The LED must not be repositioned after soldering.
- * After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- * Direct soldering onto a PC board should be avoided. Mechanical stress to the resin may be caused by the PC board warping or from the clinching and cutting of the leadframes. When it is absolutely necessary, the LEDs may be mounted in this fashion, but, the user will assume responsibility for any problems. Direct soldering should only be done after testing has confirmed that no damage, such as wire bond failure or resin deterioration, will occur. LEDs should not be soldered directly to double sided PC boards because the heat will deteriorate the epoxy resin.
- * When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.
- * Cut the LED leadframes at room temperature. Cutting the leadframes at high temperature may cause LED failure.



ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com